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98D 14942 D

 **$\mu$ PD70108 (V20™)  
8/16-BIT HIGH-PERFORMANCE  
CMOS MICROPROCESSOR**

T-49-17-07

**Description**

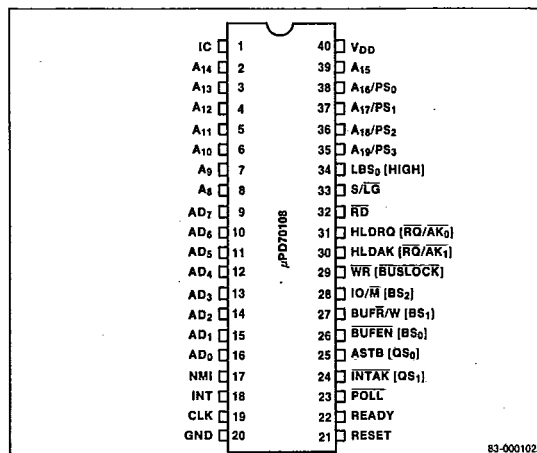
The  $\mu$ PD70108 (V20) is a CMOS 16-bit microprocessor with internal 16-bit architecture and an 8-bit external data bus. The  $\mu$ PD70108 instruction set is a superset of the  $\mu$ PD8086/8088; however, mnemonics and execution times are different. The  $\mu$ PD70108 additionally has a powerful instruction set including bit processing, packed BCD operations, and high-speed multiplication/division operations. The  $\mu$ PD70108 can also execute the entire 8080 instruction set and comes with a standby mode that significantly reduces power consumption. It is software-compatible with the  $\mu$ PD70116 16-bit microprocessor.

**Features**

- ☐ Minimum instruction execution time: 250 ns (at 8 MHz)
- ☐ Maximum addressable memory: 1 Mbyte
- ☐ Abundant memory addressing modes
- ☐ 14 x 16-bit register set
- ☐ 101 instructions
- ☐ Instruction set is a superset of  $\mu$ PD8086/8088 instruction set
- ☐ Bit, byte, word, and block operations
- ☐ Bit field operation instructions
- ☐ Packed BCD instructions
- ☐ Multiplication/division instruction execution time: 4  $\mu$ s to 6  $\mu$ s (at 8 MHz)
- ☐ High-speed block transfer instructions: 1 Mbyte/s (at 8 MHz)
- ☐ High-speed calculation of effective addresses: 2 clock cycles in any addressing mode
- ☐ Maskable (INT) and nonmaskable (NMI) interrupt inputs
- ☐ IEEE-796 bus compatible interface
- ☐ 8080 emulation mode
- ☐ CMOS technology
- ☐ Low-power consumption
- ☐ Low-power standby mode
- ☐ Single power supply
- ☐ 5 MHz, 8 MHz or 10 MHz clock

**Ordering Information**

Part Number	Package Type	Max Frequency of Operation
$\mu$ PD70108C-5	40-pin plastic DIP	5 MHz
$\mu$ PD70108C-8	40-pin plastic DIP	8 MHz
$\mu$ PD70108D-5	40-pin ceramic DIP	5 MHz
$\mu$ PD70108D-8	40-pin ceramic DIP	8 MHz
$\mu$ PD70108D-10	40-pin ceramic DIP	10 MHz
$\mu$ PD70108G-5	52-pin miniflat	5 MHz
$\mu$ PD70108G-8	52-pin miniflat	8 MHz
$\mu$ PD70108L-5	44-pin PLCC	5 MHz
$\mu$ PD70108L-8	44-pin PLCC	8 MHz

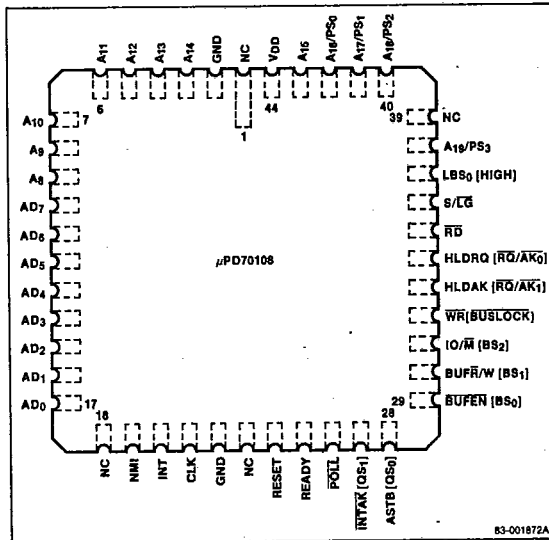
**Pin Configurations****40-Pin Plastic DIP/Cerdip**

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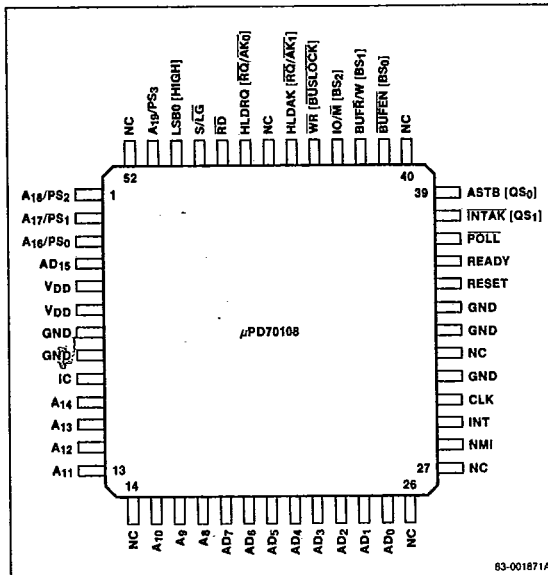
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**Pin Configurations (cont)****44-Pin Plastic Leadless Chip Carrier (PLCC)**

83-001872A

**52-Pin Plastic Miniflat**

83-001871A

**Pin Identification**

Symbol	Direction	Function
IC*		Internally connected
A <sub>14</sub> - A <sub>8</sub>	Out	Address bus, middle bits
AD <sub>7</sub> - AD <sub>0</sub>	In/Out	Address/data bus
NMI	In	Nonmaskable interrupt input
INT	in	Maskable interrupt input
CLK	In	Clock input
GND		Ground potential
RESET	In	Reset input
READY	In	Ready input
POLL	In	Poll input
INTAK (QS <sub>1</sub> )	Out	Interrupt acknowledge output (queue status bit 1 output)
ASTB (QS <sub>0</sub> )	Out	Address strobe output (queue status bit 0 output)
BUFEN (BS <sub>0</sub> )	Out	Buffer enable output (bus status bit 0 output)
BUF/W (BS <sub>1</sub> )	Out	Buffer read/write output (bus status bit 1 output)
IO/M (BS <sub>2</sub> )	Out	Access is I/O or memory (bus status bit 2 output)
WR (BUSLOCK)	Out	Write strobe output (bus lock output)
HLDK (RD/AK <sub>1</sub> )	Out (In/Out)	Hold acknowledge output, (bus hold request input/acknowledge output 1)
HLDRQ (RD/AK <sub>0</sub> )	In (In/Out)	Hold request input (bus hold request input/acknowledge output 0)
RD	Out	Read strobe output
S/LG	In	Small-scale/large-scale system input
LBS <sub>0</sub> (HIGH)	Out	Latched bus status output 0 (always high in large-scale systems)
A <sub>19</sub> /PS <sub>3</sub> - A <sub>16</sub> /PS <sub>0</sub>	Out	Address bus, high bits or processor status output
A <sub>15</sub>	Out	Address bus, bit 15
VDD		Power supply

**Notes:** \* IC should be connected to ground.

Where pins have different functions in small- and large-scale systems, the large-scale system pin symbol and function are in parentheses.

Unused input pins should be tied to ground or VDD to minimize power dissipation and prevent the flow of potentially harmful currents.

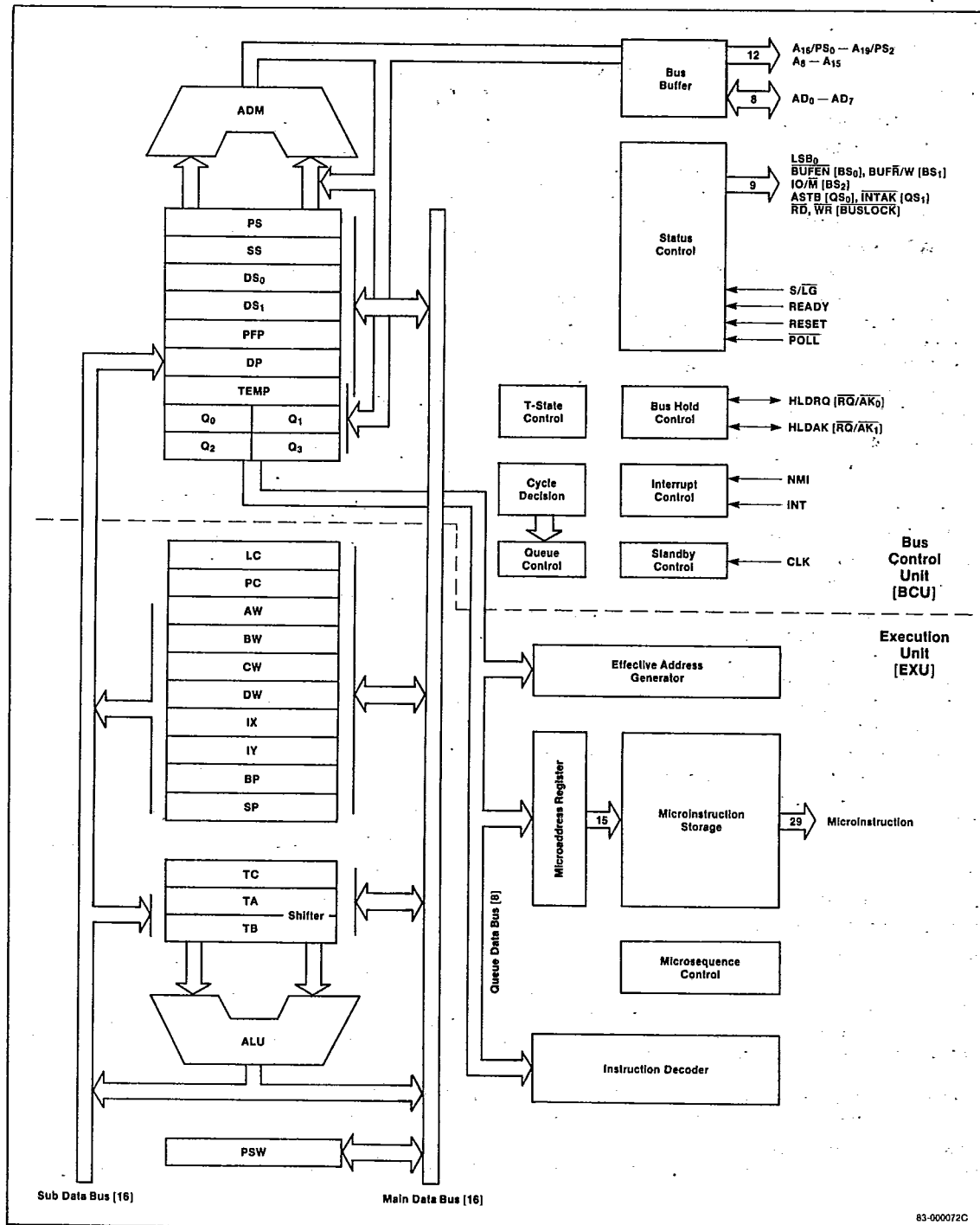
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**Block Diagram**



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**Pin Functions**

Some pins of the μPD70108 have different functions according to whether the microprocessor is used in a small- or large-scale system. Other pins function the same way in either type of system.

**A<sub>15</sub> - A<sub>8</sub> [Address Bus]**

For small- and large-scale systems.

The CPU uses these pins to output the middle 8 bits of the 20-bit address data. They are three-state outputs and become high impedance during hold acknowledge.

**AD<sub>7</sub> - AD<sub>0</sub> [Address/Data Bus]**

For small- and large-scale systems.

The CPU uses these pins as the time-multiplexed address and data bus. When high, an AD bit is a one; when low, an AD bit is a zero. This bus contains the lower 8 bits of the 20-bit address during T<sub>1</sub> of the bus cycle and is used as an 8-bit data bus during T<sub>2</sub>, T<sub>3</sub>, and T<sub>4</sub> of the bus cycle.

Sixteen-bit data I/O is performed in two steps. The low byte is sent first, followed by the high byte. The address/data bus is a three-state bus and can be at a high or low level during standby mode. The bus will be high impedance during hold and interrupt acknowledge.

**NMI [Nonmaskable Interrupt]**

For small- and large-scale systems.

This pin is used to input nonmaskable interrupt requests. NMI cannot be masked by software. This input is positive edge triggered and must be held high for five clocks to guarantee recognition. Actual interrupt processing begins, however, after completion of the instruction in progress.

The contents of interrupt vector 2 determine the starting address for the interrupt-servicing routine. Note that a hold request will be accepted even during NMI acknowledge.

This interrupt will cause the μPD70108 to exit the standby mode.

**INT [Maskable Interrupt]**

For small- and large-scale systems.

This pin is an interrupt request that can be masked by software.

INT is active high level and is sensed during the last clock of the instruction. The interrupt will be accepted if the interrupt enable flag IE is set. The CPU outputs the INTAK signal to inform external devices that the interrupt request has been granted. INT must be asserted until the interrupt acknowledge is returned.

If NMI and INT interrupts occur at the same time, NMI has higher priority than INT and INT cannot be

accepted. A hold request will be accepted during INT acknowledge.

This interrupt causes the μPD70108 to exit the standby mode.

**CLK [Clock]**

For small- and large-scale systems.

This pin is used for external clock input.

**RESET [Reset]**

For small- and large-scale systems.

This pin is used for the CPU reset signal. It is an active high level. Input of this signal has priority over all other operations. After the reset signal input returns to a low level, the CPU begins execution of the program starting at address FFFF0H.

In addition to causing normal CPU start, RESET input will cause the μPD70108 to exit the standby mode.

**READY [Ready]**

For small- and large-scale systems.

When the memory or I/O device being accessed cannot complete data read or write within the CPU basic access time, it can generate a CPU wait state (T<sub>w</sub>) by setting this signal to inactive (low level) and requesting a read/write cycle delay.

If the READY signal is active (high level) during either the T<sub>3</sub> or T<sub>w</sub> state, the CPU will not generate a wait state.

**POLL [Poll]**

For small- and large-scale systems.

The CPU checks this input upon execution of the  $\overline{\text{POLL}}$  instruction. If the input is low, then execution continues. If the input is high, the CPU will check the  $\overline{\text{POLL}}$  input every five clock cycles until the input becomes low again.

The  $\overline{\text{POLL}}$  and READY functions are used to synchronize CPU program execution with the operation of external devices.

 **$\overline{\text{RD}}$  [Read Strobe]**

For small- and large-scale systems.

The CPU outputs this strobe signal during data read from an I/O device or memory. The  $\text{IO}/\overline{\text{M}}$  signal is used to select between I/O and memory.

The three-state output is held high during standby mode and enters the high-impedance state during hold acknowledge.

**S/ $\overline{\text{LG}}$  [Small/Large]**

For small- and large-scale systems.

This signal determines the operation mode of the CPU. This signal is fixed at either a high or low level. When

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this signal is a high level, the CPU will operate in small-scale system mode, and when low, in the large-scale system mode. A small-scale system will have at most one bus master such as a DMA controller device on the bus. A large-scale system can have more than one bus master accessing the bus as well as the CPU.

**INTAK [Interrupt Acknowledge]**

For small-scale systems.

The CPU generates the **INTAK** signal low when it accepts an INT signal.

The interrupting device synchronizes with this signal and outputs the interrupt vector to the CPU via the data bus (AD<sub>7</sub> - AD<sub>0</sub>).

**ASTB [Address Strobe]**

For small-scale systems.

The CPU outputs this strobe signal to latch address information at an external latch.

ASTB is held at a low level during standby mode and hold acknowledge.

**BUFEN [Buffer Enable]**

For small-scale systems.

This is used as the output enable signal for an external bidirectional buffer. The CPU generates this signal during data transfer operations with external memory or I/O devices or during input of an interrupt vector.

This three-state output is held high during standby mode and enters the high-impedance state during hold acknowledge.

**BUF $\bar{R}$ /W [Buffer Read/Write]**

For small-scale systems.

The output of this signal determines the direction of data transfer with an external bidirectional buffer. A high output causes transmission from the CPU to the external device; a low signal causes data transfer from the external device to the CPU.

BUF $\bar{R}$ /W is a three-state output and becomes high impedance during hold acknowledge.

**IO/ $\bar{M}$  [IO/Memory]**

For small-scale systems.

The CPU generates this signal to specify either I/O access or memory access. A high-level output specifies I/O and a low-level signal specifies memory.

IO/M's output is three state and becomes high impedance during hold acknowledge.

**WR [Write Strobe]**

For small-scale systems.

The CPU generates this strobe signal during data write to an I/O device or memory. Selection of either I/O or memory is performed by the IO/M signal.

This three-state output is held high during standby mode and enters the high-impedance state during hold acknowledge.

**HLD $\bar{A}$ K [Hold Acknowledge]**

For small-scale systems.

The HLD $\bar{A}$ K signal is used to indicate that the CPU accepts the hold request signal (HLD $\bar{R}$ Q). When this signal is a high level, the address bus, address/data bus, and the control lines become high impedance.

**HLD $\bar{R}$ Q [Hold Request]**

For small-scale systems.

This input signal is used by external devices to request the CPU to release the address bus, address/data bus, and the control bus.

**LBS<sub>0</sub> [Latched Bus Status 0]**

For small-scale systems.

The CPU uses this signal along with the IO/ $\bar{M}$  and BUF $\bar{R}$ /W signals to inform an external device what the current bus cycle is.

IO/ $\bar{M}$	BUF $\bar{R}$ /W	LBS <sub>0</sub>	Bus Cycle
0	0	0	Program fetch
0	0	1	Memory read
0	1	0	Memory write
0	1	1	Passive state
1	0	0	Interrupt acknowledge
1	0	1	I/O read
1	1	0	I/O write
1	1	1	Halt

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**A<sub>19</sub>/PS<sub>3</sub> - A<sub>16</sub>/PS<sub>0</sub> [Address Bus/Processor Status]**  
For small- and large-scale systems.

These pins are time multiplexed to operate as an address bus and as processor status signals.

When used as the address bus, these pins are the high 4 bits of the 20-bit memory address. During I/O access, all 4 bits output data 0.

The processor status signals are provided for both memory and I/O use. PS<sub>3</sub> is always 0 in the native mode and 1 in 8080 emulation mode. The interrupt enable flag (IE) is pin on pin PS<sub>2</sub>. Pins PS<sub>1</sub> and PS<sub>0</sub> indicate which memory segment is being accessed.

A <sub>17</sub> /PS <sub>1</sub>	A <sub>16</sub> /PS <sub>0</sub>	Segment
0	0	Data segment 1
0	1	Stack segment
1	0	Program segment
1	1	Data segment 0

The output of these pins is three state and becomes high impedance during hold acknowledge.

**QS<sub>1</sub>, QS<sub>0</sub> [Queue Status]**

For large-scale systems.

The CPU uses these signals to allow external devices, such as the floating-point arithmetic processor chip, (μPD72091) to monitor the status of the internal CPU instruction queue.

QS <sub>1</sub>	QS <sub>0</sub>	Instruction Queue Status
0	0	NOP (queue does not change)
0	1	First byte of instruction
1	0	Flush queue
1	1	Subsequent bytes of instruction

The instruction queue status indicated by these signals is the status when the execution unit (EXU) accesses the instruction queue. The data output from these pins is therefore valid only for one clock cycle immediately following queue access. These status signals are provided so that the floating-point processor chip can monitor the CPU's program execution status and synchronize its operation with the CPU when control is passed to it by the FPO (Floating Point Operation) instructions.

**BS<sub>2</sub> - BS<sub>0</sub> [Bus Status]**

For large-scale systems.

The CPU uses these status signals to allow an external bus controller to monitor what the current bus cycle is.

The external bus controller decodes these signals and generates the control signals required to perform access of the memory or I/O device.

BS <sub>2</sub>	BS <sub>1</sub>	BS <sub>0</sub>	Bus Cycle
0	0	0	Interrupt acknowledge
0	0	1	I/O read
0	1	0	I/O write
0	1	1	Halt
1	0	0	Program fetch
1	0	1	Memory read
1	1	0	Memory write
1	1	1	Passive state

The output of these signals is three state and becomes high impedance during hold acknowledge.

**BUSLOCK [Bus Lock]**

For large-scale systems.

The CPU uses this signal to secure the bus while executing the instruction immediately following the BUSLOCK prefix instruction, or during an interrupt acknowledge cycle. It is a status signal to the other bus masters in a multiprocessor system, inhibiting them from using the system bus during this time.

The output of this signal is three state and becomes high impedance during hold acknowledge. BUSLOCK is high during standby mode except if the HALT instruction has a BUSLOCK prefix.

**RQ/AK<sub>1</sub>, RQ/AK<sub>0</sub> [Hold Request/Acknowledge]**

For large-scale systems.

These pins function as bus hold request inputs ( $\overline{RQ}$ ) and as bus hold acknowledge outputs ( $\overline{AK}$ ). RQ/AK<sub>0</sub> has a higher priority than RQ/AK<sub>1</sub>.

These pins have three-state outputs with on-chip pull-up resistors which keep the pin at a high level when the output is high impedance.

**V<sub>DD</sub> [Power Supply]**

For small- and large-scale systems.

This pin is used for the +5 V power supply.

**GND [Ground]**

For small- and large-scale systems.

This pin is used for ground.

**IC [Internally Connected]**

This pin is used for tests performed at the factory by NEC. The μPD70108 is used with this pin at ground potential.

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**Absolute Maximum Ratings** $T_A = +25^\circ\text{C}$ 

Power supply voltage, $V_{DD}$	-0.5 V to +7.0 V
Power dissipation, $PD_{MAX}$	0.5 W
Input voltage, $V_I$	-0.5 V to $V_{DD} + 0.3$ V
CLK input voltage, $V_K$	-0.5 V to $V_{DD} + 1.0$ V
Output voltage, $V_O$	-0.5 V to $V_{DD} + 0.3$ V
Operating temperature, $T_{OP}$	-40°C to +85°C
Storage temperature, $T_{STG}$	-65°C to +150°C

**Comment:** Exposing the device to stresses above those listed in Absolute Maximum Ratings could cause permanent damage. The device is not meant to be operated under conditions outside the limits described in the operational sections of this specification. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**Capacitance** $T_A = +25^\circ\text{C}$ ,  $V_{DD} = 0$  V

Parameter	Symbol	Limits		Unit	Test Conditions
		Min	Max		
Input capacitance	$C_I$		15	pF	$f_c = 1$ MHz
I/O capacitance	$C_{IO}$		15	pF	Unmeasured pins returned to 0 V

**DC Characteristics** $\mu\text{PD70108-5}$ ,  $T_A = -40^\circ\text{C}$  to  $+85^\circ\text{C}$ ,  $V_{DD} = +5$  V  $\pm 10\%$  $\mu\text{PD70108-8}$ ,  $\mu\text{PD70108-10}$ ,  $T_A = -10^\circ\text{C}$  to  $+70^\circ\text{C}$ ,  $V_{DD} = +5$  V  $\pm 5\%$ 

Parameter	Symbol	Limits			Unit	Test Conditions
		Min	Typ	Max		
Input voltage high	$V_{IH}$	2.2		$V_{DD} + 0.3$	V	
Input voltage low	$V_{IL}$	-0.5		0.8	V	
CLK input voltage high	$V_{KH}$	3.9		$V_{DD} + 1.0$	V	
CLK input voltage low	$V_{KL}$	-0.5		0.6	V	
Output voltage high	$V_{OH}$	$0.7 \times V_{DD}$			V	$I_{OH} = -400 \mu\text{A}$
Output voltage low	$V_{OL}$			0.4	V	$I_{OL} = 2.5 \text{ mA}$
Input leakage current high	$I_{LIH}$			10	$\mu\text{A}$	$V_I = V_{DD}$
Input leakage current low	$I_{LIL}$			-10	$\mu\text{A}$	$V_I = 0$ V
Output leakage current high	$I_{LOH}$			10	$\mu\text{A}$	$V_O = V_{DD}$
Output leakage current low	$I_{LOL}$			-10	$\mu\text{A}$	$V_O = 0$ V
Supply current	$I_{DD}$	70108-5	30	60	mA	Normal operation
		5 MHz	5	10	mA	Standby mode
		70108-8	45	80	mA	Normal operation
		8 MHz	6	12	mA	Standby mode
		70108-10	60	100	mA	Normal operation
		10 MHz	7	14	mA	Standby mode

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**AC Characteristics**μPD70108-5, T<sub>A</sub> = -40°C to +85°C, V<sub>DD</sub> = +5 V ± 10%μPD70108-8, μPD70108-10, T<sub>A</sub> = -10°C to +70°C, V<sub>DD</sub> = +5 V ± 5%

Parameter	Symbol	$\mu$ PD70108-5		$\mu$ PD70108-8		$\mu$ PD70108-10		Unit	Conditions
		Min	Max	Min	Max	Min	Max		
Small/Large Scale									
Clock cycle	t <sub>CYK</sub>	200	500	125	500	100	500	ns	
Clock pulse width high	t <sub>KKH</sub>	69		44		41		ns	V <sub>KH</sub> = 3.0 V
Clock pulse width low	t <sub>KKL</sub>	90		60		49		ns	V <sub>KL</sub> = 1.5 V
Clock rise time	t <sub>KR</sub>		10		8		5	ns	1.5 V to 3.0 V
Clock fall time	t <sub>KF</sub>		10		7		5	ns	3.0 V to 1.5 V
READY inactive setup to CLK↓	t <sub>SRYLK</sub>	-8		-8		-10		ns	
READY inactive hold after CLK↑	t <sub>HKRYH</sub>	30		20		20		ns	
READY active setup to CLK↑	t <sub>SRYHK</sub>	t <sub>KKL</sub> - 8		t <sub>KKL</sub> - 8		t <sub>KKL</sub> - 10		ns	
READY active hold after CLK↑	t <sub>HKRYL</sub>	30		20		20		ns	
Data setup time to CLK ↓	t <sub>SDK</sub>	30		20		10		ns	
Data hold time after CLK ↓	t <sub>HKD</sub>	10		10		10		ns	
NMI, INT, POLL setup time to CLK ↑	t <sub>SIK</sub>	30		15		15		ns	
Input rise time (except CLK)	t <sub>IR</sub>		20		20		20	ns	0.8 V to 2.2 V
Input fall time (except CLK)	t <sub>IF</sub>		12		12		12	ns	2.2 V to 0.8 V
Output rise time	t <sub>OR</sub>		20		20		20	ns	0.8 V to 2.2 V
Output fall time	t <sub>OF</sub>		12		12		12	ns	2.2 V to 0.8 V
Small Scale									
Address delay time from CLK	t <sub>DKA</sub>	10	90	10	60	10	48	ns	
Address hold time from CLK	t <sub>HKA</sub>	10		10		10		ns	
PS delay time from CLK ↓	t <sub>DKP</sub>	10	90	10	60	10	50	ns	
PS float delay time from CLK ↑	t <sub>FKP</sub>	10	80	10	60	10	50	ns	
Address setup time to ASTB ↓	t <sub>SAST</sub>	t <sub>KKL</sub> - 60		t <sub>KKL</sub> - 30		t <sub>KKL</sub> - 30		ns	
Address float delay time from CLK ↓	t <sub>FKA</sub>	t <sub>HKA</sub>	80	t <sub>HKA</sub>	60	t <sub>HKA</sub>	50	ns	C <sub>L</sub> = 100 pF
ASTB ↑ delay time from CLK ↓	t <sub>DKSTH</sub>		80		50		40	ns	
ASTB ↓ delay time from CLK ↑	t <sub>DKSTL</sub>		85		55		45	ns	
ASTB width high	t <sub>STST</sub>	t <sub>KKL</sub> - 20		t <sub>KKL</sub> - 10		t <sub>KKL</sub> - 10		ns	
Address hold time from ASTB ↓	t <sub>HSTA</sub>	t <sub>KKH</sub> - 10		t <sub>KKH</sub> - 10		t <sub>KKH</sub> - 10		ns	



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**AC Characteristics (cont)**μPD70108-5, T<sub>A</sub> = -40°C to +85°C, V<sub>DD</sub> = +5 V ± 10%μPD70108-8, μPD70108-10, T<sub>A</sub> = -10°C to +70°C, V<sub>DD</sub> = +5 V ± 5%

Parameter	Symbol	$\mu$ PD70108-5		$\mu$ PD70108-8		$\mu$ PD70108-10		Unit	Conditions
		Min	Max	Min	Max	Min	Max		
Small Scale (cont)									
Control delay time from CLK	t <sub>DKCT</sub>	10	110	10	65	10	55	ns	C <sub>L</sub> = 100 pF
Address float to $\overline{\text{RD}}$ ↓	t <sub>AFRL</sub>	0		0		0		ns	
$\overline{\text{RD}}$ ↓ delay time from CLK ↓	t <sub>DKRL</sub>	10	165	10	80	10	70	ns	
$\overline{\text{RD}}$ ↑ delay time from CLK ↓	t <sub>DKRH</sub>	10	150	10	80	10	60	ns	
Address delay time from $\overline{\text{RD}}$ ↑	t <sub>DRHA</sub>	t <sub>CYK</sub> - 45		t <sub>CYK</sub> - 40		t <sub>CYK</sub> - 35		ns	
$\overline{\text{RD}}$ width low	t <sub>RR</sub>	2t <sub>CYK</sub> - 75		2t <sub>CYK</sub> - 50		2t <sub>CYK</sub> - 40		ns	
Data output delay time from CLK ↓	t <sub>DKD</sub>	10	90	10	60	10	50	ns	
Data float delay time from CLK ↓	t <sub>FKD</sub>	10	80	10	60	10	50	ns	
WR width low	t <sub>WW</sub>	2t <sub>CYK</sub> - 60		2t <sub>CYK</sub> - 40		2t <sub>CYK</sub> - 35		ns	
HLDRQ setup time to CLK ↑	t <sub>SHQK</sub>	35		20		20		ns	
HLDAK delay time from CLK ↓	t <sub>DKHA</sub>	10	160	10	100	10	60	ns	
Large Scale									
Address delay time from CLK	t <sub>DKA</sub>	10	90	10	60	10	48	ns	C <sub>L</sub> = 100 pF
Address hold time from CLK	t <sub>HKA</sub>	10		10		10		ns	
PS delay time from CLK ↓	t <sub>DKP</sub>	10	90	10	60	10	50	ns	
PS float delay time from CLK ↑	t <sub>FKP</sub>	10	80	10	60	10	50	ns	
Address float delay time from CLK ↓	t <sub>FKA</sub>	t <sub>HKA</sub>	80	t <sub>HKA</sub>	60	t <sub>HKA</sub>	50	ns	
Address delay time from $\overline{\text{RD}}$ ↑	t <sub>DRHA</sub>	t <sub>CYK</sub> - 45		t <sub>CYK</sub> - 40		t <sub>CYK</sub> - 35		ns	
ASTB delay time from BS ↓	t <sub>DBST</sub>		15		15		15	ns	
BS ↓ delay time from CLK ↑	t <sub>DKBL</sub>	10	110	10	60	10	50	ns	
BS ↑ delay time from CLK ↓	t <sub>DKBH</sub>	10	130	10	65	10	50	ns	
$\overline{\text{RD}}$ ↓ delay time from address float	t <sub>DAFRL</sub>	0		0		0		ns	
$\overline{\text{RD}}$ ↓ delay time from CLK ↓	t <sub>DKRL</sub>	10	165	10	80	10	70	ns	
$\overline{\text{RD}}$ ↑ delay time from CLK ↓	t <sub>DKRH</sub>	10	150	10	80	10	60	ns	
$\overline{\text{RD}}$ width low	t <sub>RR</sub>	2t <sub>CYK</sub> - 75		2t <sub>CYK</sub> - 50		2t <sub>CYK</sub> - 40		ns	
Date output delay time from CLK ↓	t <sub>DKD</sub>	10	90	10	60	10	50	ns	
Data float delay time from CLK ↑	t <sub>FKD</sub>	10	80	10	60	10	50	ns	
AK delay time from CLK ↓	t <sub>DKAK</sub>		70		50		40	ns	
$\overline{\text{RQ}}$ setup time to CLK ↑	t <sub>SRQK</sub>	20		10		9		ns	
$\overline{\text{RQ}}$ hold time after CLK ↑	t <sub>HKRQ</sub>	40		30		20		ns	

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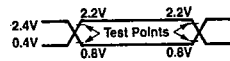
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$\mu$ PD70108 (V20)

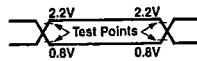
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## Timing Waveforms

### AC Test Input Waveform [Except CLK]

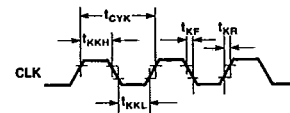


### AC Output Test Points



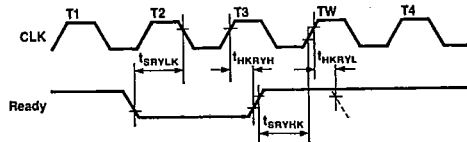
49-000238A

### Clock Timing

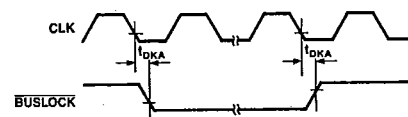


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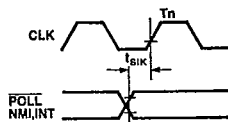
### Wait (Ready) Timing



### BUSLOCK Output Timing



### POLL, NMI, INT Input Timing



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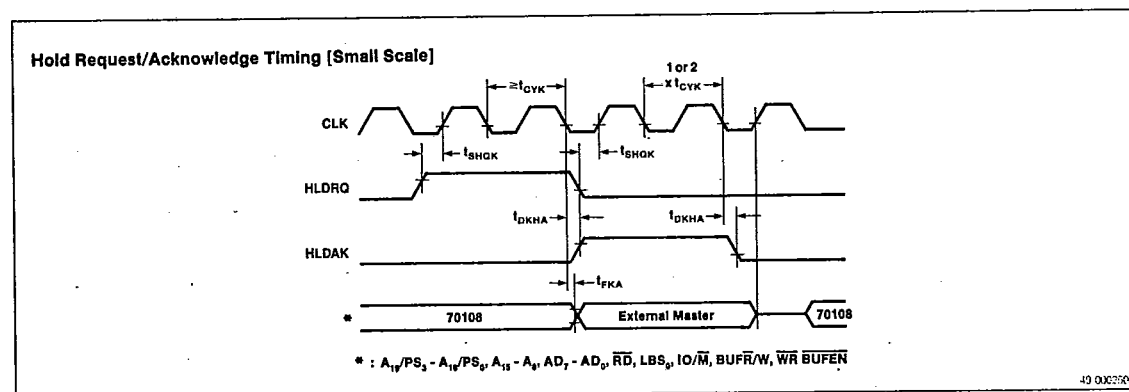
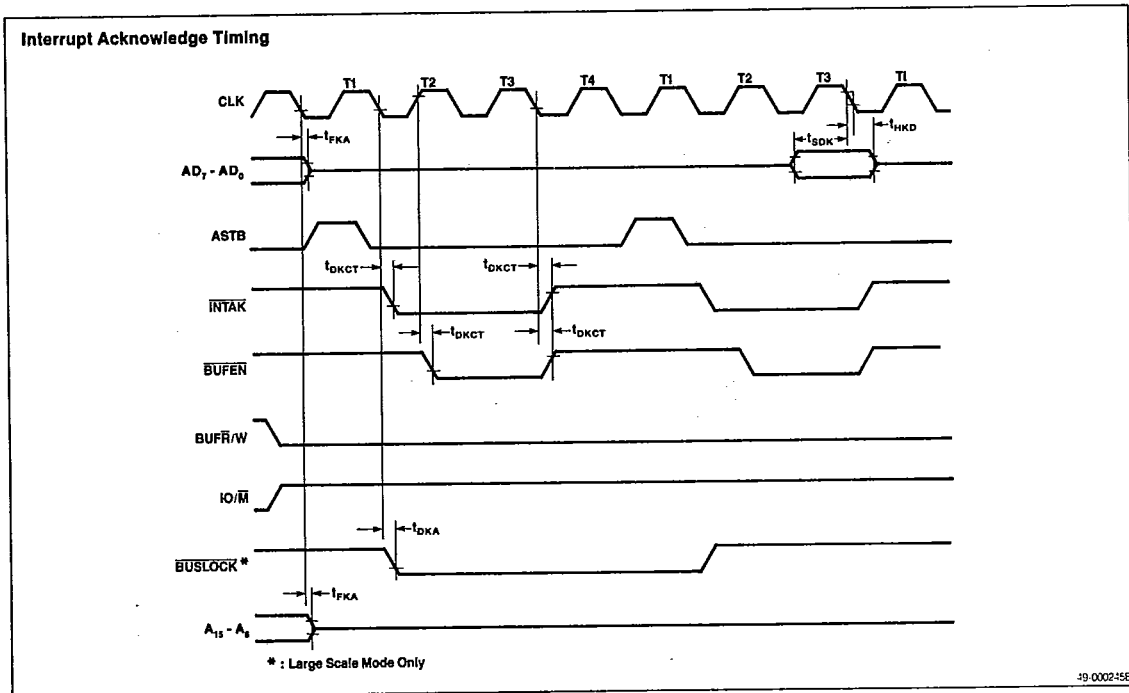
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### Timing Waveforms (cont)





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**Register Configuration****Program Counter [PC]**

The program counter is a 16-bit binary counter that contains the segment offset address of the next instruction which the EXU is to execute.

The PC increments each time the microprogram fetches an instruction from the instruction queue. A new location value is loaded into the PC each time a branch, call, return, or break instruction is executed. At this time, the contents of the PC are the same as the Prefetch Pointer (PFP).

**Prefetch Pointer [PFP]**

The prefetch pointer (PFP) is a 16-bit binary counter which contains a segment offset which is used to calculate a program memory address that the bus control unit (BCU) uses to prefetch the next byte for the instruction queue. The contents of PFP are an offset from the PS (Program Segment) register.

The PFP is incremented each time the BCU prefetches an instruction from the program memory. A new location will be loaded into the PFP whenever a branch, call, return, or break instruction is executed. At that time the contents of the PFP will be the same as those of the PC (Program Counter).

**Segment Registers [PS, SS, DS<sub>0</sub>, and DS<sub>1</sub>]**

The memory addresses accessed by the μPD70108 are divided into 64K-byte logical segments. The starting (base) address of each segment is specified by a 16-bit segment register, and the offset from this starting address is specified by the contents of another register or by the effective address.

These are the four types of segment registers used.

Segment Register	Default Offset
PS (Program Segment)	PFP
SS (Stack Segment)	SP, effective address
DS <sub>0</sub> (Data Segment 0)	IX, effective address
DS <sub>1</sub> (Data Segment 1)	IY

**General-Purpose Registers [AW, BW, CW, and DW]**

There are four 16-bit general-purpose registers. Each one can be used as one 16-bit register or as two 8-bit registers by dividing them into their high and low bytes (AH, AL, BH, BL, CH, CL, DH, DL).

Each register is also used as a default register for processing specific instructions. The default assignments are:

AW: Word multiplication/division, word I/O, data conversion

AL: Byte multiplication/division, byte I/O, BCD rotation, data conversion, translation

AH: Byte multiplication/division

BW: Translation

CW: Loop control branch, repeat prefix

CL: Shift instructions, rotation instructions, BCD operations

DW: Word multiplication/division, indirect addressing I/O

**Pointers [SP, BP] and Index Registers [IX, IY]**

These registers serve as base pointers or index registers when accessing the memory using based addressing, indexed addressing, or based indexed addressing.

These registers can also be used for data transfer and arithmetic and logical operations in the same manner as the general-purpose registers. They cannot be used as 8-bit registers.

Also, each of these registers acts as a default register for specific operations. The default assignments are:

SP: Stack operations

IX: Block transfer (source), BCD string operations

IY: Block transfer (destination), BCD string operations

**Program Status Word [PSW]**

The program status word consists of the following six status and four control flags.

**Status Flags**

- V (Overflow)
- S (Sign)
- Z (Zero)
- AC (Auxiliary Carry)
- P (Parity)
- CY (Carry)

**Control Flags**

- MD (Mode)
- DIR (Direction)
- IE (Interrupt Enable)
- BRK (Break)

When the PSW is pushed on the stack, the word images of the various flags are as shown here.

PSW															
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
M	1	1	1	V	D	I	B	S	Z	0	A	0	P	1	C
D					I	E	R				C				Y
					R		K								

The status flags are set and reset depending upon the result of each type of instruction executed.

Instructions are provided to set, reset, and complement the CY flag directly.

Other instructions set and reset the control flags and control the operation of the CPU.

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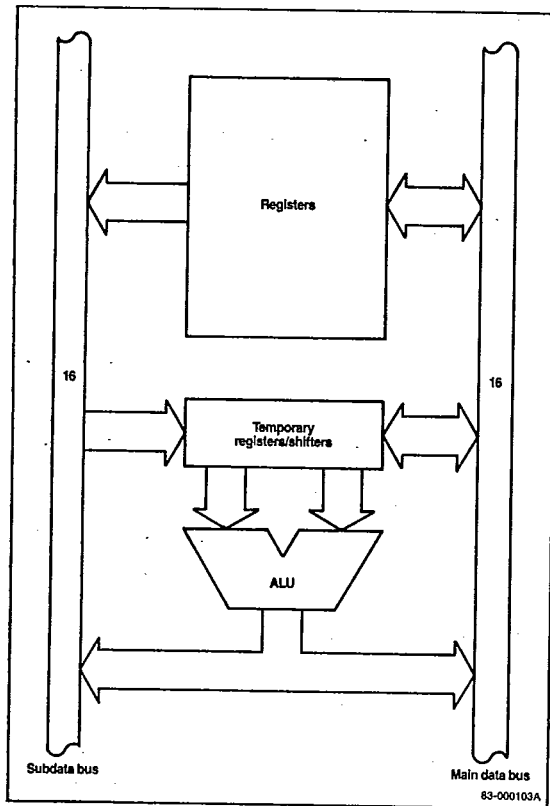
**High-Speed Execution of Instructions**

This section highlights the major architectural features that enhance the performance of the μPD70108.

- Dual data bus in EXU
- Effective address generator
- 16/32-bit temporary registers/shifters (TA, TB)
- 16-bit loop counter
- PC and PFP

**Dual Data Bus Method**

To reduce the number of processing steps for instruction execution, the dual data bus method has been adopted for the μPD70108 (figure 1). The two data buses (the main data bus and the subdata bus) are both 16 bits wide. For addition/subtraction and logical and comparison operations, processing time has been speeded up some 30% over single-bus systems.

**Figure 1. Dual Data Buses****Example**

ADD AW, BW ;  $AW \leftarrow AW + BW$

**Single Bus**

Step 1  $TA \leftarrow AW$

Step 2  $TB \leftarrow BW$

Step 3  $AW \leftarrow TA + TB$

**Dual Bus**

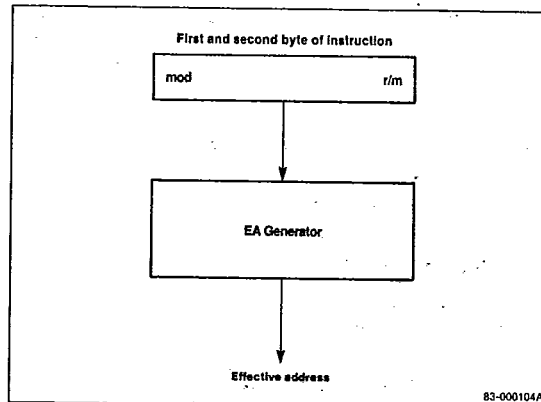
$TA \leftarrow AW, TB \leftarrow BW$

$AW \leftarrow TA + TB$

**Effective Address Generator**

This circuit (figure 2) performs high-speed processing to calculate effective addresses for accessing memory.

Calculating an effective address by the microprogramming method normally requires 5 to 12 clock cycles. This circuit requires only two clock cycles for addresses to be generated for any addressing mode. Thus, processing is several times faster.

**Figure 2. Effective Address Generator****16/32-Bit Temporary Registers/Shifters [TA, TB]**

These 16-bit temporary registers/shifters (TA, TB) are provided for multiplication/division and shift/rotation instructions.

These circuits have decreased the execution time of multiplication/division instructions. In fact, these instructions can be executed about four times faster than with the microprogramming method.

TA + TB: 32-bit temporary register/shifter for multiplication and division instructions.

TB: 16-bit temporary register/shifter for shift/rotation instructions.

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**Loop Counter [LC]**

This counter is used to count the number of loops for a primitive block transfer instruction controlled by a repeat prefix instruction and the number of shifts that will be performed for a multiple bit shift/rotation instruction.

The processing performed for a multiple bit rotation of a register is shown below. The average speed is approximately doubled over the microprogram method.

**Example**

RORC AW, CL ; CL = 5

**Microprogram method      LC method**

8 + (4 x 5) = 28 clocks      7 + 5 = 12 clocks

**Program Counter and Prefetch Pointer [PC and PFP]**

The μPD70108 microprocessor has a program counter, (PC) which addresses the program memory location of the instruction to be executed next, and a prefetch pointer (PFP), which addresses the program memory location to be accessed next. Both functions are provided in hardware. A time saving of several clocks is realized for branch, call, return, and break instruction execution, compared with microprocessors that have only one instruction pointer.

**Enhanced Instructions**

In addition to the μPD8088/86 instructions, the μPD70108 has the following enhanced instructions.

Instruction	Function
PUSH imm	Pushes immediate data onto stack
PUSH R	Pushes 8 general registers onto stack
POP R	Pops 8 general registers from stack
MUL imm	Executes 16-bit multiply of register or memory contents by immediate data
SHL imm8 SHR imm8 SHRA imm8 ROL imm8 ROR imm8 ROLC imm8 RORC imm8	Shifts/rotates register or memory by immediate value
CHKIND	Checks array index against designated boundaries
INM	Moves a string from an I/O port to memory
OUTM	Moves a string from memory to an I/O port
PREPARE	Allocates an area for a stack frame and copies previous frame pointers
DISPOSE	Frees the current stack frame on a procedure exit

**Enhanced Stack Operation Instructions****PUSH imm**

This instruction allows immediate data to be pushed onto the stack.

**PUSH R/POP R**

These instructions allow the contents of the eight general registers to be pushed onto or popped from the stack with a single instruction.

**Enhanced Multiplication Instructions****MUL reg16, imm16/MUL mem16, imm16**

These instructions allow the contents of a register or memory location to be 16-bit multiplied by immediate data.

**Enhanced Shift and Rotate Instructions****SHL reg, imm8/SHR reg, imm8/SHRA reg, imm8**

These instructions allow the contents of a register to be shifted by the number of bits defined by the immediate data.

**ROL reg, imm8/ROR reg, imm8/ROLC reg, imm8/RORC reg, imm8**

These instructions allow the contents of a register to be rotated by the number of bits defined by the immediate data.

**Check Array Boundary Instruction****CHKIND reg16, mem32**

This instruction is used to verify that index values pointing to the elements of an array data structure are within the defined range. The lower limit of the array should be in memory location mem32, the upper limit in mem32 + 2. If the index value in reg16 is not between these limits when CHKIND is executed, a BRK 5 will occur. This causes a jump to the location in interrupt vector 5.

**Block I/O Instructions****OUTM DW, src-block/INM dst-block, DW**

These instructions are used to output or input a string to or from memory, when preceded by a repeat prefix.

**Stack Frame Instructions****PREPARE imm16, imm8**

This instruction is used to generate the stack frames required by block-structured languages, such as PASCAL and Ada. The stack frame consists of two areas. One area has a pointer that points to another frame which has variables that the current frame can access. The other is a local variable area for the current procedure.



**NEC****DISPOSE**

This instruction releases the last stack frame generated by the PREPARE instruction. It returns the stack and base pointers to the values they had before the PREPARE instruction was used to call a procedure.

**Unique Instructions**

In addition to the μPD8088/86 instructions and the enhanced instructions, the μPD70108 has the following unique instructions.

Instruction	Function
INS	Insert bit field
EXT	Extract bit field
ADD4S	Adds packed decimal strings
SUB4S	Subtracts one packed decimal string from another
CMP4S	Compares two packed decimal strings
ROL4	Rotates one BCD digit left through AL lower 4 bits
ROR4	Rotates one BCD digit right through AL lower 4 bits
TEST1	Tests a specified bit and sets/resets Z flag
NOT1	Inverts a specified bit
CLR1	Clears a specified bit
SET1	Sets a specified bit
REPC	Repeats next instruction until CY flag is cleared
REPNC	Repeats next instruction until CY flag is set
FP02	Additional floating point processor call

**Variable Length Bit Field Operation Instructions**

This category has two instructions: INS (Insert Bit Field) and EXT (Extract Bit Field). These instructions are highly effective for computer graphics and high-level languages. They can, for example, be used for data structures such as packed arrays and record type data used in PASCAL.

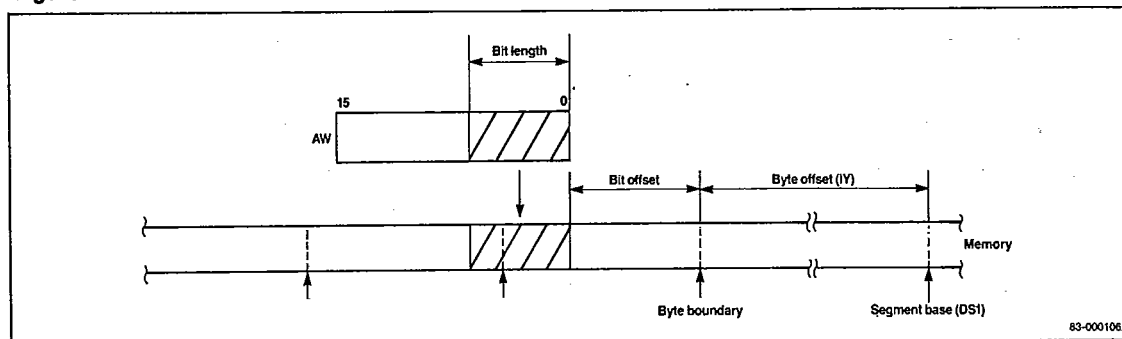
**INS reg8, reg8/INS reg8, imm4**

This instruction (figure 3) transfers low bits from the 16-bit AW register (the number of bits is specified by the second operand) to the memory location specified by the segment base (DS<sub>1</sub> register) plus the byte offset (IY register). The starting bit position within this byte is specified as an offset by the lower 4-bits of the first operand.

After each complete data transfer, the IY register and the register specified by the first operand are automatically updated to point to the next bit field.

Either immediate data or a register may specify the number of bits transferred (second operand). Because the maximum transferable bit length is 16-bits, only the lower 4-bits of the specified register (00H to 0FH) will be valid.

Bit field data may overlap the byte boundary of memory.

**3****Figure 3. Bit Field Insertion**

**EXT reg8, reg8/EXT reg8, imm4**

This instruction (figure 4) loads to the AW register the bit field data whose bit length is specified by the second operand of the instruction from the memory location that is specified by the DS0 segment register (segment base), the IX index register (byte offset), and the lower 4-bits of the first operand (bit offset).

After the transfer is complete, the IX register and the lower 4-bits of the first operand are automatically updated to point to the next bit field.

Either immediate data or a register may be specified for the second operand. Because the maximum transferable bit length is 16 bits, however, only the lower 4-bits of the specified register (0H to 0FH) will be valid.

Bit field data may overlap the byte boundary of memory.

**Packed BCD Operation Instructions**

The instructions described here process packed BCD data either as strings (ADD4S, SUB4S, CMP4S) or byte-format operands (ROR4, ROL4). Packed BCD strings may be from 1 to 254 digits in length.

When the number of digits is even, the zero and carry flags will be set according to the result of the operation. When the number of digits is odd, the zero and carry flags may not be set correctly in this case, (CL = odd), the zero flag will not be set unless the upper 4 bits of the highest byte are all zero. The carry flag will not be set unless there is a carry out of the upper 4 bits of the highest byte. When CL is odd, the contents of the upper 4 bits of the highest byte of the result are undefined.

**ADD4S**

This instruction adds the packed BCD string addressed by the IX index register to the packed BCD string addressed by the IY index register, and stores the result in the string addressed by the IY register. The length of the string (number of BCD digits) is specified by the CL register, and the result of the operation will affect the overflow flag (V), the carry flag (CY), and zero flag (Z).

BCD string (IY, CL) ← BCD string (IY, CL) + BCD string (IX, CL)

**SUB4S**

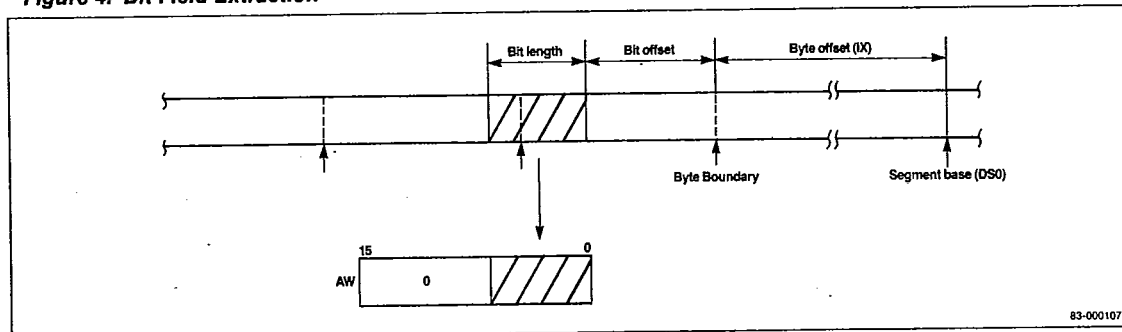
This instruction subtracts the packed BCD string addressed by the IX index register from the packed BCD string addressed by the IY register, and stores the result in the string addressed by the IY register. The length of the string (number of BCD digits) is specified by the CL register, and the result of the operation will affect the overflow flag (V), the carry flag (CY), and zero flag (Z).

BCD string (IY, CL) ← BCD string (IY, CL) - BCD String (IX, CL)

**CMP4S**

This instruction performs the same operation as SUB4S except that the result is not stored and only the overflow (V), carry flags (CY) and zero flag (Z) are affected.

BCD string (IY, CL) - BCD string (IX, CL)

**Figure 4. Bit Field Extraction**

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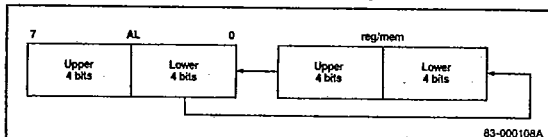
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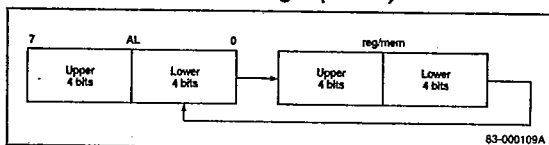
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**ROL4**

This instruction (figure 5) treats the byte data of the register or memory directly specified by the instruction byte as BCD data and uses the lower 4-bits of the AL register (AL<sub>L</sub>) to rotate that data one BCD digit to the left.

**Figure 5. BCD Rotate Left (ROL4)****ROR4**

This instruction (figure 6) treats the byte data of the register or memory directly specified by the instruction byte as BCD data and uses the lower 4-bits of the AL register (AL<sub>L</sub>) to rotate that data one BCD digit to the right.

**Figure 6. BCD Rotate Right (ROR4)****Bit Manipulation Instructions****TEST1**

This instruction tests a specific bit in a register or memory location. If the bit is 1, the Z flag is reset to 0. If the bit is 0, the Z flag is set to 1.

**NOT1**

This instruction inverts a specific bit in a register or memory location.

**CLR1**

This instruction clears a specific bit in a register or memory location.

**SET1**

This instruction sets a specific bit in a register or memory location.

**Repeat Prefix Instructions****REPC**

This instruction causes the μPD70108 to repeat the following primitive block transfer instruction until the CY flag becomes cleared or the CW register becomes zero.

**REPNC**

This instruction causes the μPD70108 to repeat the following primitive block transfer instruction until the CY flag becomes set or the CW register is decremented to zero.

**Floating Point Instruction****FPO2**

This instruction is in addition to the μPD8088/86 floating point instruction, FPO1. These instructions are covered in a later section.

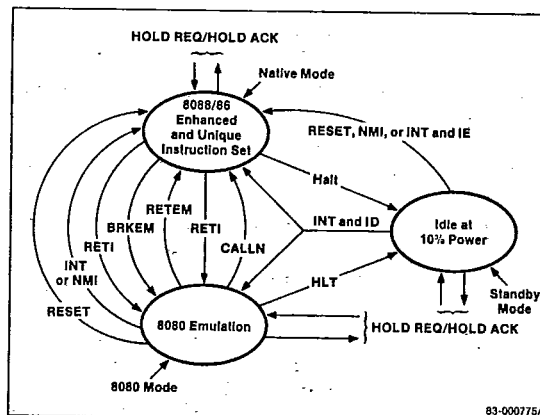
**Mode Operation Instructions**

The μPD70108 has two operating modes (figure 7). One is the native mode which executes μPD8088/86, enhanced and unique instructions. The other is the 8080 emulation mode in which the instruction set of the μPD8080AF is emulated. A mode flag (MD) is provided to select between these two modes. Native mode is selected when MD is 1 and emulation mode when MD is 0. MD is set and reset, directly and indirectly, by executing the mode manipulation instructions.

Two instructions are provided to switch operation from the native mode to the emulation mode and back: BRKEM (Break for Emulation), and RETEM (Return from Emulation).

Two instructions are used to switch from the emulation mode to the native mode and back: CALLN (Call Native Routine), and RETI (Return from Interrupt).

The system will return from the 8080 emulation mode to the native mode when the RESET signal is present, or when an external interrupt (NMI or INT) is present.

**Figure 7. V20 Modes**

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**BRKEM imm8**

This is the basic instruction used to start the 8080 emulation mode. This instruction operates exactly the same as the BRK instruction, except that BRKEM resets the mode flag (MD) to 0. PSW, PS, and PC are saved to the stack. MD is then reset and the interrupt vector specified by the operand imm8 of this command is loaded into PS and PC.

The instruction codes of the interrupt processing routine jumped to are then fetched. Then the CPU executes these codes as μPD8080AF instructions.

In 8080 emulation mode, registers and flags of the μPD8080AF are performed by the following registers and flags of the μPD70108.

	μPD8080AF	μPD70108
Registers:		
	A	AL
	B	CH
	C	CL
	D	DH
	E	DL
	H	BH
	L	BL
	SP	BP
	PC	PC
Flags:		
	C	CY
	Z	Z
	S	S
	P	P
	AC	AC

In the native mode, SP is used for the stack pointer. In the 8080 emulation mode this function is performed by BP.

This use of independent stack pointers allows independent stack areas to be secured for each mode and keeps the stack of one of the modes from being destroyed by an erroneous stack operation in the other mode.

The SP, IX, IY and AH registers and the four segment registers (PS, SS, DS<sub>0</sub>, and DS<sub>1</sub>) used in the native mode are not affected by operations in 8080 emulation mode.

In the 8080 emulation mode, the segment register for instructions is determined by the PS register (set automatically by the interrupt vector) and the segment register for data is the DS<sub>0</sub> register (set by the programmer immediately before the 8080 emulation mode is entered).

It is prohibited to nest BRKEM instructions.

**RETEM [no operand]**

When RETEM is executed in 8080 emulation mode (interpreted by the CPU as a μPD8080AF instruction), the CPU restores PS, PC, and PSW (as it would when returning from an interrupt processing routine), and returns to the native mode. At the same time, the contents of the mode flag (MD) which was saved to the stack by the BRKEM instruction, is restored to MD = 1. The CPU is set to the native mode.

**CALLN imm8**

This instruction makes it possible to call the native mode subroutines from the 8080 emulation mode. To return from subroutine to the emulation mode, the RETI instruction is used.

The processing performed when this instruction is executed in the 8080 emulation mode (it is interpreted by the CPU as μPD8080AF instruction), is similar to that performed when a BRK instruction is executed in the native mode. The imm8 operand specifies an interrupt vector type. The contents of PS, PC, and PSW are pushed on the stack and an MD flag value of 0 is saved. The mode flag is set to 1 and the interrupt vector specified by the operand is loaded into PS and PC.

**RETI [no operand]**

This is a general-purpose instruction used to return from interrupt routines entered by the BRK instruction or by an external interrupt in the native mode. When this instruction is executed at the end of a subroutine entered by the execution of the CALLN instruction, the operation that restores PS, PC, and PSW is exactly the same as the native mode execution. When PSW is restored, however, the 8080 emulation mode value of the mode flag (MD) is restored, the CPU is set in emulation mode, and all subsequent instructions are interpreted and executed as μPD8080AF instructions.

RETI is also used to return from an interrupt procedure initiated by an NMI or INT interrupt in the emulation mode.

**Floating Point Operation Chip Instructions****FPO1 fp-op, mem/FPO2 fp-op, mem**

These instructions are used for the external floating point processor. The floating point operation is passed to the floating point processor when the CPU fetches one of these instructions. From this point the CPU performs only the necessary auxiliary processing (effective address calculation, generation of physical addresses, and start-up of the memory read cycle).

The floating point processor always monitors the instructions fetched by the CPU. When it interprets one as an instruction to itself, it performs the appropriate processing. At this time, the floating point processor chip uses either the address alone or both the address and read data of the memory read cycle executed by the CPU. This difference in the data used depends on which of these instructions is executed.

**Note:** During the memory read cycle initiated by the CPU for FPO1 or FPO2 execution, the CPU does not accept any read data on the data bus from memory. Although the CPU generates the memory address, the data is used by the floating point processor.

### Interrupt Operation

The interrupts used in the μPD70108 can be divided into two types: interrupts generated by external interrupt requests and interrupts generated by software processing. These are the classifications.

#### External Interrupts

- (a) NMI input (nonmaskable)
- (b) INT input (maskable)

#### Software Processing

As the result of instruction execution

- When a divide error occurs during execution of the DIV or DIVU instruction
- When a memory-boundary-over error is detected by the CHKIND instruction

Conditional break instruction

- When V = 1 during execution of the BRKV instruction

Unconditional break instructions

- 1-byte break instruction: BRK3
- 2-byte break instruction: BRK imm8

Flag processing

- When stack operations are used to set the BRK flag

8080 Emulation mode instructions

- BRKEM imm8
- CALLN imm8

### Interrupt Vectors

Starting addresses for interrupt processing routines are either determined automatically by a single location of the interrupt vector table or selected each time interrupt processing is entered.

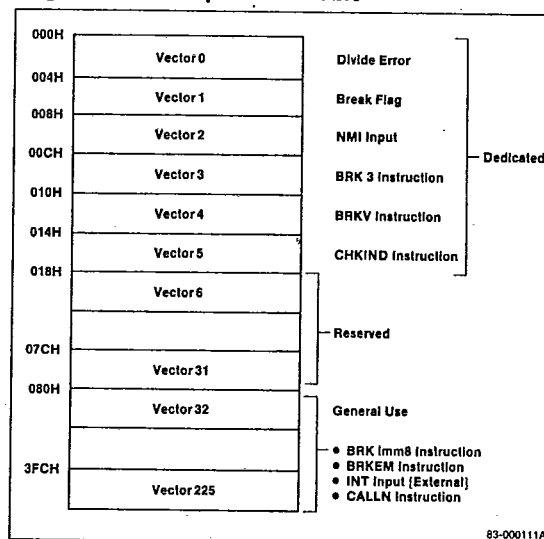
The interrupt vector table is shown in figure 8. The table uses 1K bytes of memory addresses 000H to 3FFH and can store starting address data for a maximum of 256 vectors (4 bytes per vector).

The corresponding interrupt sources for vectors 0 to 5 are predetermined and vectors 6 to 31 are reserved. These vectors consequently cannot be used for general applications.

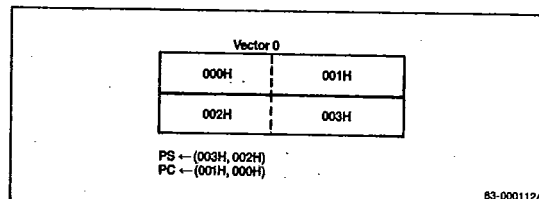
The BRKEM instruction and CALLN instruction (in the emulation mode) and the INT input are available for general applications for vectors 32 to 255.

A single interrupt vector is made up of 4 bytes (figure 9). The 2 bytes in the low addresses of memory are loaded into PC as the offset, and the high 2 bytes are loaded into PS as the base address. The bytes are combined in reverse order. The lower-order bytes in the vector become the most significant bytes in the PC and PS, and the higher-order bytes become the least significant bytes.

**Figure 8. Interrupt Vector Table**



**Figure 9. Interrupt Vector 0**



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Based on this format, the contents of each vector should be initialized at the beginning of the program.

The basic steps to jump to an interrupt processing routine are now shown.

```
(SP - 1, SP - 2) ← PSW
(SP - 3, SP - 4) ← PS
(SP - 5, SP - 6) ← PC
SP ← SP - 6
IE ← 0, BRK ← 0, MD ← 1
PS ← vector high bytes
PC ← vector low bytes
```

**Standby Function**

The μPD70108 has a standby mode to reduce power consumption during program wait states. This mode is set by the HALT instruction in both the native and the emulation mode.

In the standby mode, the internal clock is supplied only to those circuits related to functions required to release this mode and bus hold control functions. As a result, power consumption can be reduced to 1/10 the level of normal operation in either native or emulation mode.

The standby mode is released by inputting a RESET signal or an external interrupt (NMI, INT).

The bus hold function is effective during standby mode. The CPU returns to standby mode when the bus hold request is removed.

During standby mode, all control outputs are disabled and the address/data bus will be at either high or low levels.

**Instruction Set****Symbols**

Preceding the instruction set, several tables explain symbols, abbreviations, and codes.

**Clocks**

In the Clocks column of the instruction set, the numbers cover these operations: instruction decoding, effective address calculation, operand fetch, and instruction execution.

Clock timings assume the instruction has been pre-fetched and is present in the four-byte instruction queue. Otherwise, add four clocks for each byte not present.

For instructions that reference memory operands, the number on the left side of the slash (/) is for byte operands and the number on the right side is for word operands.

For conditional control transfer or branch instructions, the number on the left side of the slash is applicable if the transfer or branch takes place. The number on the right side is applicable if it does not take place.

If a range of numbers is given, the execution time depends on the operands involved.

**Symbols**

Symbol	Meaning
acc	Accumulator (AW or AL)
disp	Displacement (8 or 16 bits)
dmem	Direct memory address
dst	Destination operand or address
ext-disp8	16-bit displacement (sign-extension byte + 8-bit displacement)
far_label	Label within a different program segment
far_proc	Procedure within a different program segment
fp_op	Floating point instruction operation
imm	8- or 16-bit immediate operand
imm3/4	3/4-bit immediate bit offset
imm8	8-bit immediate operand
imm16	16-bit immediate operand
mem	Memory field (000 to 111); 8- or 16-bit memory location
mem8	8-bit memory location
mem16	16-bit memory location
mem32	32-bit memory location
memptr16	Word containing the destination address within the current segment
memptr32	Double word containing a destination address in another segment
mod	Mode field (00 to 10)
near_label	Label within the current segment
near_proc	Procedure within the current segment
offset	Immediate offset data (16 bits)
pop_value	Number of bytes to discard from the stack
reg	Register field (000 to 111); 8- or 16-bit general-purpose register
reg8	8-bit general-purpose register
reg16	16-bit general-purpose register
regptr	16-bit register containing a destination address within the current segment
regptr16	Register containing a destination address within the current segment
seg	Immediate segment data (16 bits)
short_label	Label between -128 and +127 bytes from the end of the current instruction

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μPD70108 (V20)**Symbols (cont)**

Symbol	Meaning
sr	Segment register
src	Source operand or address
temp	Temporary register (8/16/32 bits)
tmpcy	Temporary carry flag (1 bit)
AC	Auxiliary carry flag
AH	Accumulator (high byte)
AL	Accumulator (low byte)
AND	Logical product
AW	Accumulator (16 bits)
BH	BW register (high byte)
BL	BW register (low byte)
BP	BP register
BRK	Break flag
BW	BW register (16 bits)
CH	CW register (high byte)
CL	CW register (low byte)
CW	CW register (16 bits)
CY	Carry flag
DH	DW register (high byte)
DIR	Direction flag
DL	DW register (low byte)
DS0	Data segment 0 register (16 bits)
DS1	Data segment 1 register (16 bits)
DW	DW register (16 bits)
IE	Interrupt enable flag
IX	Index register (source) (16 bits)

**Symbols**

Symbol	Meaning
IY	Index register (destination) (16 bits)
MD	Mode flag
OR	Logical sum
P	Parity flag
PC	Program counter (16 bits)
PS	Program segment register (16 bits)
PSW	Program status word (16 bits)
R	Register set
S	Sign extend operand field S = 0 No sign extension S = 1 Sign extend immediate byte operand
S	Sign flag
SP	Stack pointer (16 bits)
SS	Stack segment register (16 bits)
V	Overflow flag
W	Word/byte field (0 to 1)
X, XXX, YYY, ZZZ	Data to identify the instruction code of the external floating point arithmetic chip
XOR	Exclusive logical sum
XXH	Two-digit hexadecimal value
XXXXH	Four-digit hexadecimal value
Z	Zero flag
( )	Values in parentheses are memory contents
←	Transfer direction
+	Addition
-	Subtraction
x	Multiplication
÷	Division
%	Modulo

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**Flag Operations**

Symbol	Meaning
(blank)	No change
0	Cleared to 0
1	Set to 1
x	Set or cleared according to result
u	Undefined
R	Restored to previous state

**Memory Addressing Modes**

mem	mod = 00	mod = 01	mod = 10
000	BW + IX	BW + IX + disp8	BW + IX + disp16
001	BW + IY	BW + IY + disp8	BW + IY + disp16
010	BP + IX	BP + IX + disp8	BP + IX + disp16
011	BP + IY	BP + IY + disp8	BP + IY + disp16
100	IX	IX + disp8	IX + disp16
101	IY	IY + disp8	IY + disp16
110	Direct	BP + disp8	BP + disp16
111	BW	BW + disp8	BW + disp16

**Register Selection (mod = 11)**

reg	W = 0	W = 1
000	AL	AW
001	CL	CW
010	DL	DW
011	BL	BW
100	AH	SP
101	CH	BP
110	DH	IX
111	BH	IY

**Segment Register Selection**

sr	Segment Register
00	DS1
01	PS
10	SS
11	DS0



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**Instruction Set**

Mnemonic	Operand	Opcode																Clocks	Bytes	Flags					
		7	6	5	4	3	2	1	0	7	6	5	4	3	2	1	0			AC	CY	V	P	S	Z
Data Transfer Instructions																									
MOV	reg, reg	1	0	0	0	1	0	1	W	1	1		reg		reg		2		2						
	mem, reg	1	0	0	0	1	0	0	W	mod		reg		mem		9/13		2-4							
	reg, mem	1	0	0	0	1	0	1	W	mod		reg		mem		11/15		2-4							
	mem, imm	1	1	0	0	0	1	1	W	mod		reg		mem		11/15		3-6							
	reg, imm	1	0	1	1				W	reg						4		2-3							
	acc, dmem	1	0	1	0	0	0	0	W							10/14		3							
	dmem, acc	1	0	1	0	0	0	1	W							9/13		3							
	sr, reg16	1	0	0	0	1	1	1	0		1	1	0	sr		reg	2		2						
	sr, mem16	1	0	0	0	1	1	1	0	mod	0		sr		mem	11/15		2-4							
	reg16, sr	1	0	0	0	1	1	0	0		1	1	0	sr		reg	2		2						
	mem16, sr	1	0	0	0	1	1	0	0	mod	0		sr		mem	10/14		2-4							
	DS0, reg16, mem32	1	1	0	0	0	1	0	1	mod		reg		mem		18/26		2-4							
	DS1, reg16, mem32	1	1	0	0	0	1	0	0	mod		reg		mem		18/26		2-4							
	AH, PSW	1	0	0	1	1	1	1	1							2		1							
PSW, AH	1	0	0	1	1	1	1	0							3		1			x	x		x	x	x
LDEA	reg16, mem16	1	0	0	0	1	1	0	1	mod		reg		mem	4		2-4								
TRANS	src_table	1	1	0	1	0	1	1	1						9		1								
XCH	reg, reg	1	0	0	0	0	1	1	W	1	1		reg		reg	3		2							
	mem, reg	1	0	0	0	0	1	1	W	mod		reg		mem	16/26		2-4								
	AW, reg16	1	0	0	1	0			reg						3		1								
Repeat Prefixes																									
REPC		0	1	1	0	0	1	0	1						2		1								
REPNC		0	1	1	0	0	1	0	0						2		1								
REP		1	1	1	1	0	0	1	1						2		1								
REPE																									
REPZ																									
REPNE		1	1	1	1	0	0	1	0						2		1								
REPZ																									
Block Transfer Instructions																									
MOVBK	dst, src	1	0	1	0	0	1	0	W						11 + 8n		1								
CMPBK	dst, src	1	0	1	0	0	1	1	W						7 + 14n		1			x	x	x	x	x	x
CMPM	dst	1	0	1	0	1	1	1	W						7 + 10n		1			x	x	x	x	x	x
LDM	src	1	0	1	0	1	1	0	W						7 + 9n		1								
STM	dst	1	0	1	0	1	0	1	W						7 + 4n		1								
																		n = number of transfers							
I/O Instructions																									
IN	acc, imm8	1	1	1	0	0	1	0	W						9/13		2								
	acc, DW	1	1	1	0	1	1	0	W						8/12		1								
OUT	imm8, acc	1	1	1	0	0	1	1	W						8/12		2								
	DW, acc	1	1	1	0	1	1	1	W						8/12		1								
NM	dst, DW	0	1	1	0	1	1	0	W						9 + 8n		1								
OUTM	DW, src	0	1	1	0	1	1	1	W						9 + 8n		1								
																		n = number of transfers							

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**Instruction Set (cont)**

Mnemonic	Operand	Opcode																Clocks	Bytes	Flags					
		7	6	5	4	3	2	1	0	7	6	5	4	3	2	1	0			AC	CY	V	P	S	Z
BCD Instructions																									
ADJBA		0	0	1	1	0	1	1	1									3	1	x	x	u	u	u	u
ADJ4A		0	0	1	0	0	1	1	1									3	1	x	x	u	x	x	x
ADJBS		0	0	1	1	1	1	1	1									7	1	x	x	u	u	u	u
ADJ4S		0	0	1	0	1	1	1	1									7	1	x	x	u	x	x	x
ADD4S	dst, src	0	0	0	0	1	1	1	1	0	0	1	0	0	0	0	0	7 + 19n	2	u	x	u	u	u	x
SUB4S	dst, src	0	0	0	0	1	1	1	1	0	0	1	0	0	0	1	0	7 + 19n	2	u	x	u	u	u	x
CMP4S	dst, src	0	0	0	0	1	1	1	1	0	0	1	0	0	1	1	0	7 + 19n	2	u	x	u	u	u	x
ROL4	reg8	0	0	0	0	1	1	1	1	0	0	1	0	1	0	0	0	25	3						
		1	1	0	0	0			reg																
	mem8	0	0	0	0	1	1	1	1	0	0	1	0	1	0	0	0	28	3-5						
		mod	0	0	0				mem																
ROR4	reg8	0	0	0	0	1	1	1	1	0	0	1	0	1	0	1	0	29	3						
		1	1	0	0	0			reg																
	mem8	0	0	0	0	1	1	1	1	0	0	1	0	1	0	1	0	33	3-5						
		mod	0	0	0				mem																
n = number of BCD digits divided by 2																									

n = number of BCD digits divided by 2

**Data Type Conversion Instructions**

CVTBD		1	1	0	1	0	1	0	0	0	0	0	1	0	1	0	15	2	u	u	u	x	x	x
CVTDB		1	1	0	1	0	1	0	1	0	0	0	0	1	0	1	0	7	2	u	u	u	x	x
CVTBW		1	0	0	1	1	0	0	0									2	1					
CVTWL		1	0	0	1	1	0	0	1									4-5	1					

**Arithmetic Instructions**

ADD	reg, reg	0	0	0	0	0	0	1	W	1	1	reg	reg	2	2	x	x	x	x	x	x
	mem, reg	0	0	0	0	0	0	0	W	mod		reg	mem	16/24	2-4	x	x	x	x	x	x
	reg, mem	0	0	0	0	0	0	1	W	mod		reg	mem	11/15	2-4	x	x	x	x	x	x
	reg, imm	1	0	0	0	0	0	S	W	1	1	0	0	0	reg	4	3-4	x	x	x	x
	mem, imm	1	0	0	0	0	0	S	W	mod	0	0	0	mem	18/26	3-6	x	x	x	x	
	acc, imm	0	0	0	0	0	1	0	W						4	2-3	x	x	x	x	
ADDC	reg, reg	0	0	0	1	0	0	1	W	1	1	reg	reg	2	2	x	x	x	x	x	x
	mem, reg	0	0	0	1	0	0	0	W	mod		reg	mem	16/24	2-4	x	x	x	x	x	x
	reg, mem	0	0	0	1	0	0	1	W	mod		reg	mem	11/15	2-4	x	x	x	x	x	x
	reg, imm	1	0	0	0	0	0	S	W	1	1	0	1	0	reg	4	3-4	x	x	x	x
	mem, imm	1	0	0	0	0	0	S	W	mod	0	1	0	mem	18/26	3-6	x	x	x	x	
	acc, imm	0	0	0	1	0	1	0	W						4	2-3	x	x	x	x	
SUB	reg, reg	0	0	1	0	1	0	1	W	1	1	reg	reg	2	2	x	x	x	x	x	x
	mem, reg	0	0	1	0	1	0	0	W	mod		reg	mem	16/24	2-4	x	x	x	x	x	x
	reg, mem	0	0	1	0	1	0	1	W	mod		reg	mem	11/15	2-4	x	x	x	x	x	x
	reg, imm	1	0	0	0	0	0	S	W	1	1	1	0	1	reg	4	3-4	x	x	x	x

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**Instruction Set (cont)**

Mnemonic	Operand	Opcode														Clocks	Bytes	Flags					
		7	6	5	4	3	2	1	0	7	6	5	4	3	2			1	0	AC	CY	V	P
Arithmetic Instructions (cont)																							
SUBC	mem, imm	1	0	0	0	0	0	S	W	mod	1	0	1	mem	18/26	3-6	x	x	x	x	x	x	
	acc, imm	0	0	1	0	1	1	0	W						4	2-3	x	x	x	x	x	x	
	reg, reg	0	0	0	1	1	0	1	W	1	1	reg	reg	2	2		x	x	x	x	x	x	
	mem, reg	0	0	0	1	1	0	0	W	mod		reg	mem	16/24	2-4		x	x	x	x	x	x	
	reg, mem	0	0	0	1	1	0	1	W	mod		reg	mem	11/15	2-4		x	x	x	x	x	x	
	reg, imm	1	0	0	0	0	0	S	W	1	1	0	1	1	reg	4	3-4	x	x	x	x	x	x
	mem, imm	1	0	0	0	0	0	S	W	mod	0	1	1	mem	18/26	3-6	x	x	x	x	x	x	
	acc, imm	0	0	0	1	1	1	0	W						4	2-3	x	x	x	x	x	x	
INC	reg8	1	1	1	1	1	1	1	0	1	1	0	0	0	reg	2	2	x		x	x	x	x
	mem	1	1	1	1	1	1	1	W	mod	0	0	0	mem	16/24	2-4	x		x	x	x	x	
	reg16	0	1	0	0	0			reg						2	1	x		x	x	x	x	
DEC	reg8	1	1	1	1	1	1	1	0	1	1	0	0	1	reg	2	2	x		x	x	x	x
	mem	1	1	1	1	1	1	1	W	mod	0	0	1	mem	16/24	2-4	x		x	x	x	x	
	reg16	0	1	0	0	1			reg						2	1	x		x	x	x	x	
MULU	reg	1	1	1	1	0	1	1	W	1	1	1	0	0	reg	21-30	2	u	x	x	u	u	u
	mem	1	1	1	1	0	1	1	W	mod	1	0	0	mem	27-36	2-4	u	x	x	u	u	u	
MUL	reg	1	1	1	1	0	1	1	W	1	1	1	0	1	reg	33-47	2	u	x	x	u	u	u
	mem	1	1	1	1	0	1	1	W	mod	1	0	1	mem	39-57	2-4	u	x	x	u	u	u	
	reg16, reg16, imm8	0	1	1	0	1	0	1	1	1	1	reg	reg	28-34	3		u	x	x	u	u	u	
	reg16, mem16, imm8	0	1	1	0	1	0	1	1	mod		reg	mem	34-44	3-5		u	x	x	u	u	u	
	reg16, reg16, imm16	0	1	1	0	1	0	0	1	1	1	reg	reg	36-42	4		u	x	x	u	u	u	
	reg16, mem16, imm16	0	1	1	0	1	0	0	1	mod		reg	mem	46-52	4-6		u	x	x	u	u	u	
DIVU	reg	1	1	1	1	0	1	1	W	1	1	1	1	0	reg	19-25	2	u	u	u	u	u	u
	mem	1	1	1	1	0	1	1	W	mod	1	1	0	mem	25-35	2-4	u	u	u	u	u	u	
DIV	reg	1	1	1	1	0	1	1	W	1	1	1	1	1	reg	29-43	2	u	u	u	u	u	u
	mem	1	1	1	1	0	1	1	W	mod	1	1	1	mem	35-53	2-4	u	u	u	u	u	u	
Comparison Instructions																							
CMP	reg, reg	0	0	1	1	1	0	1	W	1	1	reg	reg	2	2		x	x	x	x	x	x	
	mem, reg	0	0	1	1	1	0	0	W	mod		reg	mem	11/15	2-4		x	x	x	x	x	x	
	reg, mem	0	0	1	1	1	0	1	W	mod		reg	mem	11/15	2-4		x	x	x	x	x	x	
	reg, imm	1	0	0	0	0	0	S	W	1	1	1	1	1	reg	4	3-4	x	x	x	x	x	x
	mem, imm	1	0	0	0	0	0	S	W	mod	1	1	1	mem	13/17	3-6	x	x	x	x	x	x	
	acc, imm	0	0	1	1	1	1	0	W						4	2-3	x	x	x	x	x	x	
Logical Instructions																							
NOT	reg	1	1	1	1	0	1	1	W	1	1	0	1	0	reg	2	2						
	mem	1	1	1	1	0	1	1	W	mod	0	1	0	mem	16/24	2-4							
NEG	reg	1	1	1	1	0	1	1	W	1	1	0	1	1	reg	2	2	x	x	x	x	x	x
	mem	1	1	1	1	0	1	1	W	mod	0	1	1	mem	16/24	2-4	x	x	x	x	x	x	
TEST	reg, reg	1	0	0	0	0	1	0	W	1	1	reg	reg	2	2		u	0	0	x	x	x	
	mem, reg	1	0	0	0	0	1	0	W	mod		reg	mem	10/14	2-4		u	0	0	x	x	x	
	reg, imm	1	1	1	1	0	1	1	W	1	1	0	0	0	reg	4	3-4	u	0	0	x	x	x

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**μPD70108 (V20)****NEC**  
T-49-17-07**Instruction Set (cont)**

Mnemonic	Operand	Opcode														Clocks	Bytes	Flags							
		7	6	5	4	3	2	1	0	7	6	5	4	3	2			1	0	AC	CY	V	P	S	Z
Logical Instructions (cont)																									
AND	mem, imm	1	1	1	1	0	1	1	W	mod	0	0	0	mem	11/15	3-6	u	0	0	x	x	x			
	acc, imm	1	0	1	0	1	0	0	W						4	2-3	u	0	0	x	x	x			
	reg, reg	0	0	1	0	0	0	1	W	1	1	reg	reg	2	2		u	0	0	x	x	x			
	mem, reg	0	0	1	0	0	0	0	W	mod		reg	mem	16/20	2-4		u	0	0	x	x	x			
	reg, mem	0	0	1	0	0	0	1	W	mod		reg	mem	11/15	2-4		u	0	0	x	x	x			
	reg, imm	1	0	0	0	0	0	0	W	1	1	1	0	0	reg	4	3-4	u	0	0	x	x	x		
	mem, imm	1	0	0	0	0	0	0	W	mod	1	0	0	mem	18/26	3-6	u	0	0	x	x	x			
	acc, imm	0	0	1	0	0	1	0	W						4	2-3	u	0	0	x	x	x			
OR	reg, reg	0	0	0	0	1	0	1	W	1	1	reg	reg	2	2		u	0	0	x	x	x			
	mem, reg	0	0	0	0	1	0	0	W	mod		reg	mem	16/24	2-4		u	0	0	x	x	x			
	reg, mem	0	0	0	0	1	0	1	W	mod		reg	mem	11/15	2-4		u	0	0	x	x	x			
	reg, imm	1	0	0	0	0	0	0	W	1	1	0	0	1	reg	4	3-4	u	0	0	x	x	x		
	mem, imm	1	0	0	0	0	0	0	W	mod	0	0	1	mem	18/26	3-6	u	0	0	x	x	x			
	acc, imm	0	0	1	0	0	1	0	W						4	2-3	u	0	0	x	x	x			
XOR	reg, reg	0	0	1	1	0	0	1	W	1	1	reg	reg	2	2		u	0	0	x	x	x			
	mem, reg	0	0	1	1	0	0	0	W	mod		reg	mem	16/24	2-4		u	0	0	x	x	x			
	reg, mem	0	0	1	1	0	0	1	W	mod		reg	mem	11/15	2-4		u	0	0	x	x	x			
	reg, imm	1	0	0	0	0	0	0	W	1	1	1	1	0	reg	4	3-4	u	0	0	x	x	x		
	mem, imm	1	0	0	0	0	0	0	W	mod	1	1	0	mem	18/26	3-6	u	0	0	x	x	x			
	acc, imm	0	0	1	0	0	1	0	W						4	2-3	u	0	0	x	x	x			
Bit Manipulation Instructions																									
INS	reg8, reg8	0	0	0	0	1	1	1	1	0	0	1	1	0	0	0	1	35-133	3						
		1	1	reg				reg																	
	reg8, imm8	0	0	0	0	1	1	1	1	0	0	1	1	1	0	0	1	35-133	4						
		1	1	0	0	0		reg																	
EXT	reg8, reg8	0	0	0	0	1	1	1	1	0	0	1	1	0	0	1	1	34-59	3						
		1	1	reg				reg																	
	reg8, imm8	0	0	0	0	1	1	1	1	0	0	1	1	1	0	1	1	34-59	4						
		1	1	0	0	0		reg																	
TEST1	reg, CL	0	0	0	0	1	1	1	1	0	0	0	1	0	0	0	W	3	3	u	0	0	u	u	x
		1	1	0	0	0		reg																	
	mem, CL	0	0	0	0	1	1	1	1	0	0	0	1	0	0	0	W	12/16	3-5	u	0	0	u	u	x
		mod	0	0	0		mem																		
	reg, imm3/4	0	0	0	0	1	1	1	1	0	0	0	1	1	0	0	W	4	4	u	0	0	u	u	x
		1	1	0	0	0		reg																	
	mem, imm3/4	0	0	0	0	1	1	1	1	0	0	0	1	1	0	0	W	13/21	4-6	u	0	0	u	u	x
		mod	0	0	0		mem																		
SET1	reg, CL	0	0	0	0	1	1	1	1	0	0	0	1	0	1	0	W	4	3						
		1	1	0	0	0		reg																	
	mem, CL	0	0	0	0	1	1	1	1	0	0	0	1	0	1	0	W	13/21	3-5						
		mod	0	0	0		mem																		

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**NEC**

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T-49-17-07  
μPD70108 (V20)

**Instruction Set (cont)**

Mnemonic	Operands	Opcode																Clocks	Bytes	Flags						
		7	6	5	4	3	2	1	0	7	6	5	4	3	2	1	0			AC	CY	V	P	S	Z	
Bit Manipulation Instructions (cont)																										
	reg, imm3/4	0	0	0	0	1	1	1	1	0	0	0	1	1	1	0	W	5	4							
		1	1	0	0	0			reg																	
	mem, imm3/4	0	0	0	0	1	1	1	1	0	0	0	1	1	1	0	W	14/22	4-6							
		mod	0	0	0				mem																	
	CY	1	1	1	1	1	0	0	1									2	1		1					
	DIR	1	1	1	1	1	1	0	1									2	1							
CLR1	reg, CL	0	0	0	0	1	1	1	1	0	0	0	1	0	0	1	W	5	3							
		1	1	0	0	0			reg																	
	mem, CL	0	0	0	0	1	1	1	1	0	0	0	1	0	0	1	W	14/22	3-5							
		mod	0	0	0				mem																	
	reg, imm3/4	0	0	0	0	1	1	1	1	0	0	0	1	1	0	1	W	6	4							
		1	1	0	0	0			reg																	
	mem, imm3/4	0	0	0	0	1	1	1	1	0	0	0	1	1	0	1	W	15/27	4-6							
		mod	0	0	0				mem																	
CY	1	1	1	1	1	0	0	0									2	1		0						
DIR	1	1	1	1	1	1	0	0									2	1								
NOT1	reg, CL	0	0	0	0	1	1	1	1	0	0	0	1	0	1	1	W	4	3							
		1	1	0	0	0			reg																	
	mem, CL	0	0	0	0	1	1	1	1	0	0	0	1	0	1	1	W	18/26	3-5							
		mod	0	0	0				mem																	
	reg, imm3/4	0	0	0	0	1	1	1	1	0	0	0	1	1	1	1	W	5	4							
		1	1	0	0	0			reg																	
	mem, imm3/4	0	0	0	0	1	1	1	1	0	0	0	1	1	1	1	W	19/27	4-6							
		mod	0	0	0				mem																	
CY	1	1	1	1	0	1	0	1									2	1		x						
Shift/Rotate Instructions																										
SHL	reg, 1	1	1	0	1	0	0	0	0	W	1	1	1	0	0		reg	2	2		u	x	x	x	x	
	mem, 1	1	1	0	1	0	0	0	0	W	mod	1	0	0		mem	16/24	2-4		u	x	x	x	x		
	reg, CL	1	1	0	1	0	0	1	W		1	1	1	0	0		reg	7 + n	2		u	x	u	x	x	
	mem, CL	1	1	0	1	0	0	1	W		mod	1	0	0		mem	19/27 + n	2-4		u	x	u	x	x		
	reg, imm8	1	1	0	0	0	0	0	0	W	1	1	1	0	0		reg	7 + n	3		u	x	u	x	x	
	mem, imm8	1	1	0	0	0	0	0	0	W	mod	1	0	0		mem	19/27 + n	3-5		u	x	u	x	x		
SHR	reg, 1	1	1	0	1	0	0	0	0	W	1	1	1	0	1		reg	2	2		u	x	x	x	x	
	mem, 1	1	1	0	1	0	0	0	0	W	mod	1	0	1		mem	16/24	2-4		u	x	x	x	x		
	reg, CL	1	1	0	1	0	0	1	W		1	1	1	0	1		reg	7 + n	2		u	x	u	x	x	
	mem, CL	1	1	0	1	0	0	1	W		mod	1	0	1		mem	19/27 + n	2-4		u	x	u	x	x		
	reg, imm8	1	1	0	0	0	0	0	0	W	1	1	1	0	1		reg	7 + n	3		u	x	u	x	x	
	mem, imm8	1	1	0	0	0	0	0	0	W	mod	1	0	1		mem	19/27 + n	3-5		u	x	u	x	x		
n = number of shifts																										

n = number of shifts

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**μPD70108 (V20)****NEC**  
T-49-17-07**Instruction Set (cont)**

Mnemonic	Operands	Opcode																Clocks	Bytes	Flags					
		7	6	5	4	3	2	1	0	7	6	5	4	3	2	1	0			AC	CY	V	P	S	Z
Shift/Rotate Instructions (cont)																									
SHRA	reg, 1	1	1	0	1	0	0	0	W	1	1	1	1	1	reg	2	2	u	x	0	x	x	x		
	mem, 1	1	1	0	1	0	0	0	W	mod	1	1	1	mem	16/24	2-4	u	x	0	x	x	x			
	reg, CL	1	1	0	1	0	0	1	W	1	1	1	1	1	reg	7 + n	2	u	x	u	x	x	x		
	mem, CL	1	1	0	1	0	0	1	W	mod	1	1	1	mem	19/27 + n	2-4	u	x	u	x	x	x			
	reg, imm8	1	1	0	0	0	0	0	W	1	1	1	1	1	reg	7 + n	3	u	x	u	x	x	x		
	mem, imm8	1	1	0	0	0	0	0	W	mod	1	1	1	mem	19/27 + n	3-5	u	x	u	x	x	x			
ROL	reg, 1	1	1	0	1	0	0	0	W	1	1	0	0	0	reg	2	2			x	x				
	mem, 1	1	1	0	1	0	0	0	W	mod	0	0	0	mem	16/24	2-4			x	x					
	reg, CL	1	1	0	1	0	0	1	W	1	1	0	0	0	reg	7 + n	2			x	u				
	mem, CL	1	1	0	1	0	0	1	W	mod	0	0	0	mem	19/27 + n	2-4			x	u					
	reg, imm	1	1	0	0	0	0	0	W	1	1	0	0	0	reg	7 + n	3			x	u				
	mem, imm	1	1	0	0	0	0	0	W	mod	0	0	0	mem	19/27 + n	3-5			x	u					
ROR	reg, 1	1	1	0	1	0	0	0	W	1	1	0	0	1	reg	2	2			x	u				
	mem, 1	1	1	0	1	0	0	0	W	mod	0	0	1	mem	16/24	2-4			x	x					
	reg, CL	1	1	0	1	0	0	1	W	1	1	0	0	1	reg	7 + n	2			x	u				
	mem, CL	1	1	0	1	0	0	1	W	mod	0	0	1	mem	19/27 + n	2-4			x	u					
	reg, imm8	1	1	0	0	0	0	0	W	1	1	0	0	1	reg	7 + n	3			x	u				
	mem, imm8	1	1	0	0	0	0	0	W	mod	0	0	1	mem	19/27 + n	3-5			x	u					
ROLC	reg, 1	1	1	0	1	0	0	0	W	1	1	0	1	0	reg	2	2			x	x				
	mem, 1	1	1	0	1	0	0	0	W	mod	0	1	0	mem	16/28	2-4			x	x					
	reg, CL	1	1	0	1	0	0	1	W	1	1	0	1	0	reg	7 + n	2			x	u				
	mem, CL	1	1	0	1	0	0	1	W	mod	0	1	0	mem	19/27 + n	2-4			x	u					
	reg, imm8	1	1	0	0	0	0	0	W	1	1	0	1	0	reg	7 + n	3			x	u				
	mem, imm8	1	1	0	0	0	0	0	W	mod	0	1	0	mem	19/27 + n	3-5			x	u					
RORC	reg, 1	1	1	0	1	0	0	0	W	1	1	0	1	1	reg	2	2			x	x				
	mem, 1	1	1	0	1	0	0	0	W	mod	0	1	1	mem	16/24	2-4			x	x					
	reg, CL	1	1	0	1	0	0	1	W	1	1	0	1	1	reg	7 + n	2			x	u				
	mem, CL	1	1	0	1	0	0	1	W	mod	0	1	1	mem	19/27 + n	2-4			x	u					
	reg, imm8	1	1	0	0	0	0	0	W	1	1	0	1	1	reg	7 + n	3			x	u				
	mem, imm8	1	1	0	0	0	0	0	W	mod	0	1	1	mem	19/27 + n	3-5			x	u					
n = number of shifts																									

n = number of shifts

**Stack Manipulation Instructions**

PUSH	mem16	1	1	1	1	1	1	1	1	mod	1	1	0	mem	26	2-4
	reg16	0	1	0	1	0			reg						12	1
	sr	0	0	0	sr	1	1	0							12	1
	PSW	1	0	0	1	1	1	0	0						12	1
	R	0	1	1	0	0	0	0	0						67	1
	imm	0	1	1	0	1	0	S	0						11/12	2-3

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**NEC**

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 $\mu$ PD70108 (V20)

T-49-17-01

**Instruction Set (cont)**

Mnemonic	Operands	Opcode																Clocks	Bytes	Flags					
		7	6	5	4	3	2	1	0	7	6	5	4	3	2	1	0			AC	CY	V	P	S	Z
Stack Manipulation Instructions (cont)																									
POP	mem16	1	0	0	0	1	1	1	1	mod	0	0	0		mem	25	2-4								
	reg16	0	1	0	1	1			reg							12	1								
	sr	0	0	0		sr	1	1	1							12	1								
	PSW	1	0	0	1	1	1	0	1							12	1			R	R	R	R	R	R
	R	0	1	1	0	0	0	0	1							75	1								
PREPARE	imm16, imm8	1	1	0	0	1	0	0	0	*imm8 = 0 : 12 imm8 > 1 : 19 + 8 (imm8 - 1)						*	4								
DISPOSE		1	1	0	0	1	0	0	1							10	1								
Control Transfer Instructions																									
CALL	near_proc	1	1	1	0	1	0	0	0							20	3								
	regptr	1	1	1	1	1	1	1	1	1	1	0	1	0	reg	18	1								
	memptr16	1	1	1	1	1	1	1	1	mod	0	1	0		mem	31	2-4								
	far_proc	1	0	0	1	1	0	1	0							29	5								
	memptr32	1	1	1	1	1	1	1	1	mod	0	1	1		mem	47	2-4								
RET		1	1	0	0	0	0	1	1							19	1								
	pop_value	1	1	0	0	0	0	1	0							24	3								
		1	1	0	0	1	0	1	1							29	1								
	pop_value	1	1	0	0	1	0	1	0							32	3								
BR	near_label	1	1	1	0	1	0	0	1							13	3								
	short_label	1	1	1	0	1	0	0	1							12	2								
	reg	1	1	1	1	1	1	1	1	1	1	1	0	0	reg	11	2								
	memptr16	1	1	1	1	1	1	1	1	mod	1	0	0		mem	24	2-4								
	far_label	1	1	1	0	1	0	1	0							15	5								
	memptr32	1	1	1	1	1	1	1	1	mod	1	0	1		mem	35	2-4								
BV	near_label	0	1	1	1	0	0	0	0							14/4	2								
BNV	near_label	0	1	1	1	0	0	0	1							14/4	2								
BC, BL	near_label	0	1	1	1	0	0	1	0							14/4	2								
BNC, BNL	near_label	0	1	1	1	0	0	1	1							14/4	2								
BE, BZ	near_label	0	1	1	1	0	1	0	0							14/4	2								
BNE, BNZ	near_label	0	1	1	1	0	1	0	1							14/4	2								
BNH	near_label	0	1	1	1	0	1	1	0							14/4	2								
BH	near_label	0	1	1	1	0	1	1	1							14/4	2								
BN	near_label	0	1	1	1	1	0	0	0							14/4	2								
BP	near_label	0	1	1	1	1	0	0	1							14/4	2								
BPE	near_label	0	1	1	1	1	0	1	0							14/4	2								
BPO	near_label	0	1	1	1	1	0	1	1							14/4	2								
BLT	near_label	0	1	1	1	1	1	0	0							14/4	2								
BGE	near_label	0	1	1	1	1	1	0	1							14/4	2								

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**μPD70108 (V20)****NEC**

T-49-17-07

**Instruction Set (cont)**

Instruction Set (cont.)										Opcode										Flags							
Mnemonic	Operand	7	6	5	4	3	2	1	0	7	6	5	4	3	2	1	0	Clocks	Bytes	AC	CY	V	P	S	Z		
<b>Control Transfer Instructions (cont)</b>																											
BLE	near_label	0	1	1	1	1	1	1	0									14/4	2								
BGT	near_label	0	1	1	1	1	1	1	1									14/4	2								
DBNZNE	near_label	1	1	1	0	0	0	0	0									14/5	2								
DBNZE	near_label	1	1	1	0	0	0	0	1									14/5	2								
DBNZ	near_label	1	1	1	0	0	0	1	0									13/5	2								
BCWZ	near_label	1	1	1	0	0	0	1	1									13/5	2								
<b>Interrupt Instructions</b>																											
BRK	3	1	1	0	0	1	1	0	0									50	1								
	imm8	1	1	0	0	1	1	0	1									50	2								
BRKV	imm8	1	1	0	0	1	1	1	1									52/3	1								
RETI		1	1	0	0	1	1	1	0									39	1	R	R	R	R	R	R		
CHKIND	reg16, mem32	0	1	1	0	0	0	1	0	mod	reg						mem	73-76/26	2-4								
BRKEM	imm8	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1	50	3								
<b>CPU Control Instructions</b>																											
HALT		1	1	1	1	0	1	0	0									2	1								
BUSLOCK		1	1	1	1	0	0	0	0									2	1								
FP01	fp_op	1	1	0	1	1	X	X	X	1	1	Y	Y	Y	Z	Z	Z	2	2								
	fp_op, mem	1	1	0	1	1	X	X	X	mod	Y	Y	Y				mem	15	2-4								
FP02	fp_op	0	1	1	0	0	1	1	X	1	1	Y	Y	Y	Z	Z	Z	2	2								
	fp_op, mem	0	1	1	0	0	1	1	X	mod	Y	Y	Y				mem	15	2-4								
POLL		1	0	0	1	1	0	1	1									2 + 5n	1								
		n = number of times POLL pin is sampled.																									
NOP		1	0	0	1	0	0	0	0									3	1								
DI		1	1	1	1	1	0	1	0									2	1								
EI		1	1	1	1	1	0	1	1									2	1								
<b>8080 Instruction Set Enhancements</b>																											
RETEM		1	1	1	0	1	1	0	1	1	1	1	1	1	1	0	1	39	2	R	R	R	R	R	R		
CALLN	imm8	1	1	1	0	1	1	0	1	1	1	1	0	1	1	0	1	58	3								